

Title (en)

Method and apparatus for cutting and/or scoring flat adjacent elements

Title (de)

Verfahren sowie Vorrichtung zum Rillen und/oder Schneiden von flachförmigen benachbarten Elementen

Title (fr)

Procédé de découpage/refoulage d'éléments plats adjacents et dispositif pour sa mise en oeuvre.

Publication

**EP 1060850 A2 20001220 (FR)**

Application

**EP 00108633 A 20000420**

Priority

CH 114299 A 19990618

Abstract (en)

Procedure consists of passing material strip (1) between two cutting cylinders of rotating cutter to obtain rows of adjacent elements (3a-5n) having cutting edge/pushing back line (3'-5') which extends from one end to other of strip. Offset (k) in direction of movement of strip is created along respective cutting edge/pushing back line so it does not coincide with any generating line of cylinders. An Independent claim is also included for an apparatus to produce the adjacent elements following the procedure.

IPC 1-7

**B26F 1/44**; **B31F 1/00**

IPC 8 full level

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CPC (source: EP KR US)

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Citation (applicant)

- US 3835746 A 19740917 - QUATTLEBAUM W, et al
- US 3977283 A 19760831 - HELM HERBERT W
- US 4630514 A 19861223 - OHMORI SHUNJI [JP], et al

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